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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

FAIRCHILD

SEMICONDUCTOR ™

June 1997
Revised November 2000

FST6800
10-Bit Bus Switch with Precharged Outputs

General Description

The Fairchild Switch FST6800 provides 10-bits of high-speed CMOS TTL-compatible bus switching. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise. The device precharges the B Port to a selectable bias voltage (BiasV) to minimize live insertion noise.

The device is organized as a 10-bit switch with a bus enable ($\overline{OE}$) signal. When $\overline{OE}$ is LOW, the switch is ON and Port A is connected to Port B. When $\overline{OE}$ is HIGH, the switch is OPEN and the B Port is precharged to BiasV through an equivalent 10-kΩ resistor.

Features

■ 4Ω switch connection between two ports.
■ Minimal propagation delay through the switch.
■ Low I_{CC}.
■ Zero bounce in flow-through mode.
■ Output precharge to minimize live insertion noise.
■ Control inputs compatible with TTL level.

Ordering Code:

Order Number	Package Number	Package Description
FST6800WM	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
FST6800QSC	MQA24	24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150 Wide
FST6800MTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Diagram
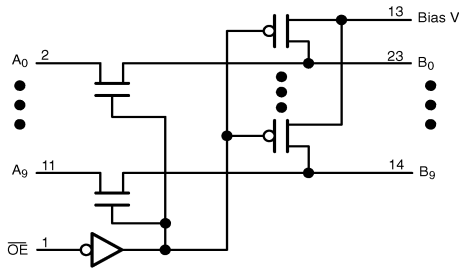
Connection Diagram
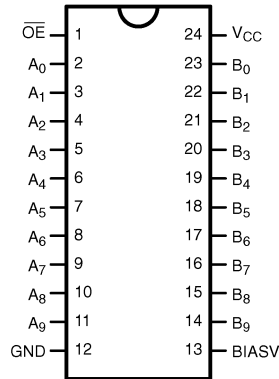
Pin Descriptions

Pin Name	Description
$\overline{OE}$	Bus Switch Enable
A	Bus A
B	Bus B

Truth Table

$\overline{OE}$	B_0–B_9	Function
L	A_0–A_9	Connect
H	BiasV	Precharge

FST6800

Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{CC})	−0.5V to +7.0V
DC Switch Voltage (V_S)	−0.5V to +7.0V
Bias V Voltage Range	−0.5V to +6.0V
DC Input Voltage (V_{IN}) (Note 2)	−0.5V to +7.0V
DC Input Diode Current (I_{IK}) V_{IN}<0V	−50mA
DC Output (I_{OUT}) Sink Current	128mA
DC V_{CC}/GND Current (I_{CC}/I_{GND})	+/− 100mA
Storage Temperature Range (T_{STG})	−65°C to +150 °C

Recommended Operating Conditions (Note 3)

Power Supply Operating (V_{CC})	4.0V to 5.5V
Precharge Supply (BiasV)	1.5V to V_{CC}
Input Voltage (V_{IN})	0V to 5.5V
Output Voltage (V_{OUT})	0V to 5.5V
Input Rise and Fall Time (t_r, t_f)	
Switch Control Input	0nS/V to 5nS/V
Switch I/O	0nS/V to DC
Free Air Operating Temperature (T_A)	−40 °C to +85 °C

Note 1: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The Recommended Operating Conditions tables will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused control inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	T_A = −40 °C to +85 °C			Units	Conditions
			Min	Typ (Note 4)	Max		
V_{IK}	Clamp Diode Voltage	4.5			−1.2	V	I_{IN} = −18mA
V_{IH}	HIGH Level Input Voltage	4.0–5.5	2.0			V	
V_{IL}	LOW Level Input Voltage	4.0–5.5			0.8	V	
I_I	Input Leakage Current	5.5			±1.0	µA	0≤ V_{IN} ≤5.5V
I_O	Output Current	4.5	0.25			mA	BiasV = 2.4V, B = 0
I_{OZ}	OFF-STATE Leakage Current	5.5			±1.0	µA	0 ≤A ≤V_{CC}
R_{ON}	Switch On Resistance	4.5		4	7	Ω	V_{IN} = 0V, I_{IN} = 64mA
	(Note 5)	4.5		4	7	Ω	V_{IN} = 0V, I_{IN} = 30mA
		4.5		8	15	Ω	V_{IN} = 2.4V, I_{IN} = 15mA
		4.0		11	20	Ω	V_{IN} = 2.4V, I_{IN} = 15mA
I_{CC}	Quiescent Supply Current	5.5			3	µA	V_{IN} = V_{CC} or GND, I_{OUT} = 0
ΔI_{CC}	Increase in I_{CC} per Input	5.5			2.5	mA	One input at 3.4V
							Other inputs at V_{CC} or GND

Note 4: Typical values are at V_{CC} = 5.0V and T_A= +25°C

Note 5: Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

AC Electrical Characteristics

Symbol	Parameter	$T_A = -40\ °C$ to $+85\ °C$, $C_L = 50pF$, RU = RD = 500Ω				Units	Conditions	Figure No.
		V_{CC} = 4.5 – 5.5V		V_{CC} = 4.0V				
		Min	Max	Min	Max			
t_{PHL},t_{PLH}	Prop Delay Bus to Bus (Note 6)		0.25		0.25	ns	V_I = OPEN	Figures 1, 2
t_{PZH}	Output Enable Time	1.5	6.2		6.5	ns	V_I = OPEN, BiasV = GND	Figures 1, 2
t_{PZL}		1.5	6.2		6.5	ns	V_I = 7V, BiasV = 3V	
t_{PHZ}	Output Disable Time	1.5	6.1		6.5	ns	V_I = OPEN, BiasV = GND	Figures 1, 2
t_{PLZ}		1.5	7.3		6.8	ns	V_I = 7V, BiasV = 3V	

Note 6: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

Capacitance (Note 7)

Symbol	Parameter	Typ	Max	Units	Conditions
C_{IN}	Control Pin Input Capacitance	3		pF	V_{CC} = 5.0V
$C_{I/O}$	Input/Output Capacitance	5		pF	V_{CC}, $\overline{OE}$ = 5.0V

Note 7: T_A = +25°C, f = 1 MHz, Capacitance is characterized but not tested.

AC Loading and Waveforms
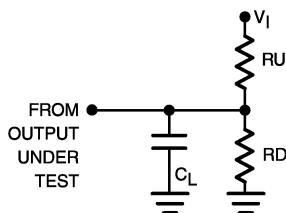
Note: Input driven by 50 Ω source terminated in 50 Ω

Note: C_L includes load and stray capacitance

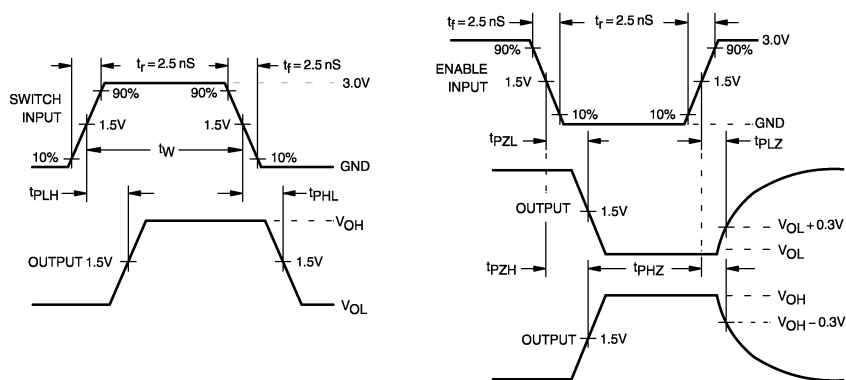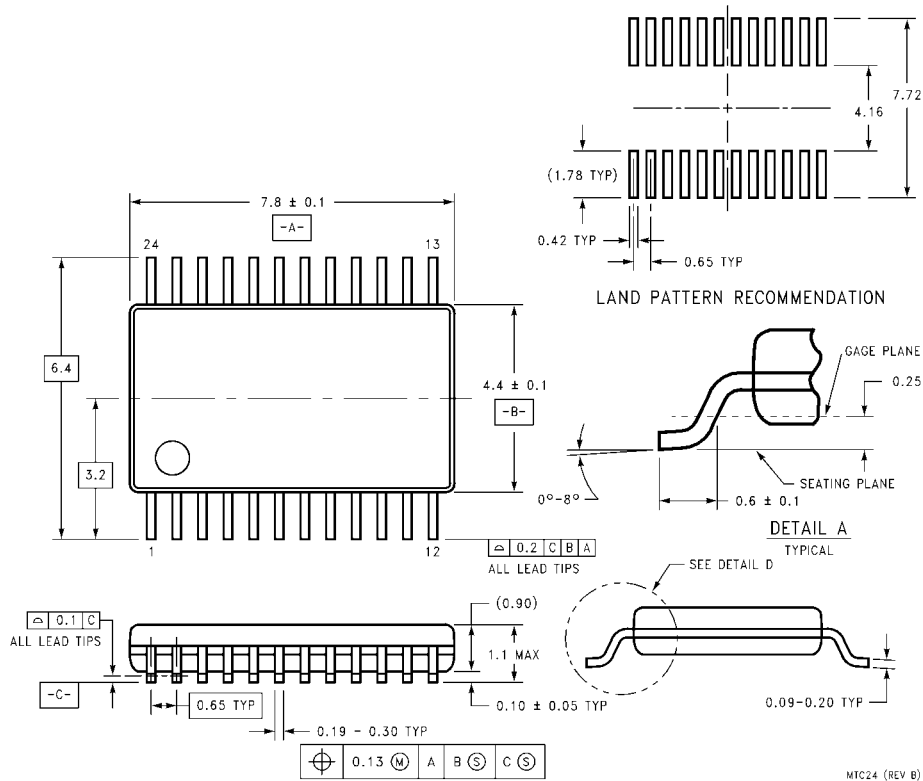**Note:** Input PRR = 1.0 MHz, t_W = 500 ns

FIGURE 1. AC Test Circuit

FIGURE 2. AC Waveforms

Physical Dimensions inches (millimeters) unless otherwise noted

24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M24B

24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150 Wide
Package Number MQA24

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

LAND PATTERN RECOMMENDATION

DETAIL A
TYPICAL

SEE DETAIL D

MTC24 (REV B)

24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC24

Technology Description

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384 (FST3384) bus switch product.

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